

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Texas Instruments</u> <u>SN65HVD09DGGR</u>

For any questions, you can email us directly: sales@integrated-circuit.com

Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008

9-CHANNEL RS-422 / RS-485 TRANSCEIVER

FEATURES

www.ti.com

- Designed to Operate at up to 20 Million Data Transfers per Second on Each RS-422/RS-485 Channel
- SN65HVD09 Packaged in Thin Shrink
 Small-Outline Package with 0.5-mm Pin Pitch
- ESD Protection on Bus Pins Exceeds 12kV
- Low Disabled Supply Current 8 mA Typ
- Thermal Shutdown Protection
- Positive- and Negative-Current Limiting
- Power-Up/Down Glitch Protection

DESCRIPTION

The SN65HVD09 is a 9-channel RS-422 / RS-485 transceiver suitable for industrial applications. It offers improved switching performance, a small package, and high ESD protection. The precise skew limits ensures that the propagation delay times, not only from channel-to-channel but from device-to-device, are closely matched for the tight skew budgets associated with high-speed parallel data buses.

Patented thermal enhancements are used in the thin shrink, small-outline package (TSSOP), allowing operation over the industrial temperature range. The TSSOP package offers very small board area requirements while reducing the package height to 1 mm. This provides more board area and allows component mounting to both sides of the printed circuit boards for low-profile, space-restricted applications such as small form-factor hard disk drives.

The HVD09 can withstand electrostatic discharges exceeding 12 kV using the human-body model, and 600 V using the machine model on the RS-485 I/O terminals. This provides protection from the noise that can be coupled into external cables. The other terminals of the device can withstand discharges exceeding 4 kV and 400 V respectively.

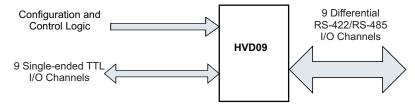
Each of the nine half-duplex channels of the HVD09 is designed to operate with either RS-422 or RS-485 communication networks.

The SN65HVD09 is characterized for operation over an ambient air temperature range of -40°C to 85°C.

SN65HVD09 DGG (TOP VIEW)

GND	1 ()	56		CDE2
BSR	2	55		CDE1
GRE	3	54		CDE0
1A 🖂	4	53		9B+
1DE/RE	5	52		9B-
2A	6	51		8B+
2DE/RE	7	50		8B-
3A	8	49		7B+
3DE/RE	9	48		7B-
4A	10	47		6B+
4DE/RE	11	46		6B-
V _{cc}	12	45		V_{cc}
GND	13	44		GND
GND	14	43		GND
GND	15	42		GND
GND	16	41		GND
GND	17	40		GND
V _{cc}	18	39		V_{cc}
5A	19	38		5B+
5DE/RE	20	37		5B-
6A	21	36		4B+
6DE/RE	22	35		4B-
7A 🗆	23	34		3B+
7DE/RE	24	33		3B-
8A	25	32		2B+
8DE/RE	26	31		2B-
9A 🗆	27	30		1B+
9DE/RE	28	29		1B-
			ı	

Terminals 13 through 17, and 40 through 44 are connected together to the package lead frame and signal ground.





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008 www.ti.com



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

PIN FUNCTIONS

PII	PIN		I/O TERMINATION		DESCRIPTION
NAME	NO.	LEVEL	1/0	TERMINATION	DESCRIPTION
1A to 9A	4,6,8,10, 19,21,23, 25,27	TTL	I/O	Pullup	1A to 9A carry data to and from the communication controller.
1B- to 9B-	29,31,33, 35,37,.46 , 48,50,52	RS-485	I/O	Pulldown	1B- to 9B- are the inverted data signals of the balanced pair to/from the bus.
1B+ to 9B+	30,32,34, 36,38,47, 49,51,53	RS-485	I/O	Pullup	1B+ to 9B+ are the noninverted data signals of the balanced pair to/from the bus.
BSR	2	TTL	Input	Pullup	BSR is the bit significant response. BSR disables receivers 1 through 8 and enables wired-OR drivers when BSR and DE/RE and CDE1 or CDE2 are high. Channel 9 is placed in a high-impedance state with BSR high.
CDE0	54	TTL	Input	Pulldown	CDE0 is the common driver enable 0. Its input signal enables all drivers when CDE0 and 1DE/ \overline{RE} – 9DE/ \overline{RE} are high.
CDE1	55	TTL	Input	Pulldown	CDE1 is the common driver enable 1. Its input signal enables drivers 1 to 4 when CDE1 is high and BSR is low.
CDE2	56	TTL	Input	Pulldown	CDE2 is the common driver enable 2. When CDE2 is high and BSR is low, drivers 5 to 8 are enabled.
CRE	3	TTL	Input	Pullup	CRE is the common receiver enable. When high, CRE disables receiver channels 5 to 9.
1DE/RE to 9DE/RE	5,7,9,11, 20,22,24, 26,28	TTL	Input	Pullup	1DE/RE-9DE/RE are direction controls that transmit data to the bus when it and CDE0 are high. Data is received from the bus when 1DE/RE-9DE/RE and CRE and BSR are low and CDE1 and CDE2 are low.
GND	1,13,14, 15,16,17, 40,41,42, 43,44	NA	Power	NA	GND is the circuit ground. All GND terminals except terminal 1 are physically tied to the die pad for improved thermal conductivity. (1)
V _{CC}	12,18,39, 45	NA	Power	NA	Supply voltage

⁽¹⁾ Terminal 1 must be connected to signal ground for proper operation.

Submit Documentation Feedback

Copyright © 2008, Texas Instruments Incorporated

2



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

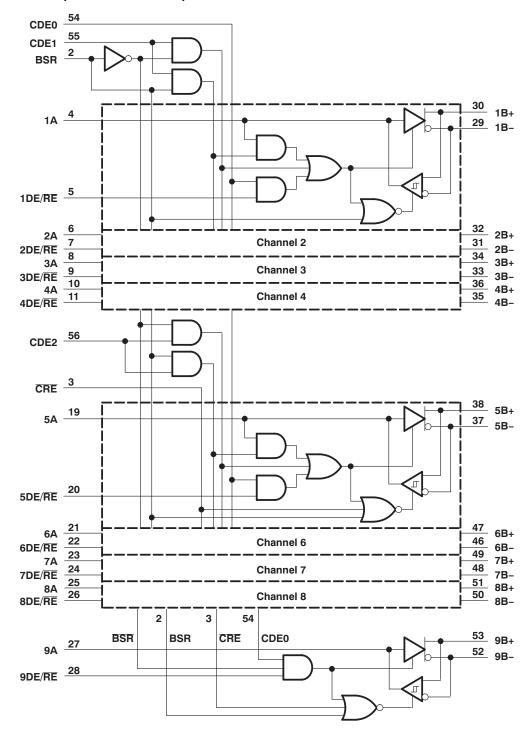


SN65HVD09

SLLS941-DECEMBER 2008

www.ti.com

LOGIC DIAGRAM (POSITIVE LOGIC)



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008 www.ti.com

ABSOLUTE MAXIMUM RATINGS(1)

			VALUE	UNIT
V_{CC}	Supply voltage range (2)		-0.3 to 6	V
	Bus voltage range		-10 to 15	V
	Data I/O and control (A signal	de) voltage range	-0.3 to V _{CC} +0.5	V
Io	Receiver output current		±40	mA
		B side and GND, Class 3, A ⁽³⁾	12	kV
	Clastrostatia dia shares	B side and GND, Class 3, B ⁽³⁾	400	V
	Electrostatic discharge	All terminals, Class 3, A	4	kV
		All terminals, Class 3, B	400	V
	Continuous total power dis	esipation (4)	Internally Limited	

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.r

DISSIPATION RATINGS

PACKAGE	TA ≤ 25°C	OPERATING FACTOR ⁽¹⁾ ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
DGG	2500 mW	20 mW/°C	1600 mW	1300 mW

⁽¹⁾ This is the inverse of the junction-to-ambient thermal resistance when board-mounted and with no air flow.

PACKAGE THERMAL CHARACTERISTICS

			MIN NOM	MAX	UNIT
θ_{JA}	Junction-to-ambient thermal resistance	DGG, board-mounted, no air flow	50		°C/W
θ_{JC}	Junction-to-case thermal resistance	DGG	27		°C/W
T_{SD}	Thermal shutdown temperature		165		°C

RECOMMENDED OPERATING CONDITIONS

			MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage		4.75	5	5.25	V
V _{IH}	High-level input voltage	Except nB+, nB-(1)	2			V
V _{IL}	Low-level input voltage	Except nb+, nb-\''			0.8	V
V _O , V _I , or V _{IC}	Voltage at any bus terminal (separately or common-mode)	nB+ or nB-	-7		12	V
	Outrat surrent	Driver	-60		60	mA
IO	Output current	Receiver	-8		8	mA
T _A	Ambient temperature	SN65HVD09	-40		85	°C

(1) n = 1 - 9

⁽²⁾ All voltage values are with respect to the GND terminals.

⁽³⁾ This absolute maximum rating is tested in accordance with MIL-PRF-38535, Method 3015.7.

⁽⁴⁾ The maximum operating junction temperature is internally limited. Use the Dissipation Rating Table to operate below this temperature.

Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

www.ti.com SLLS941-DECEMBER 2008

ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

PARAMETER TEST CONDITIONS		NO.	SI	N65HVD09		LINUT		
		TEST CONDITIONS			MIN	TYP ⁽¹⁾	MAX	UNIT
		RS-422 load,	$R_L = 100 \Omega$	See Figure 1	1	1.6		
$ V_{OD} $	Driver differential output voltage magnitude	RS-485 load,	R _L = 54 Ω	See Figure 1		1.4		V
	agag	Pull-Up Pull-Down	Load	See Figure 2	1	1.5		
\/	High-level output voltage	A side, $I_{OH} = -8 \text{ m}$	A, $V_{ID} = 200 \text{ mV}$,	See Figure 4	4	4.5		V
V _{OH}	High-level output voltage	B side,		See Figure 2		3		V
V	Low lovel output veltage	A side, I _{OH} = 8 mA	$V_{ID} = -200 \text{ mV},$	See Figure 4		0.6	0.8	V
V _{OL}	Low-level output voltage	B side,		See Figure 2		1		V
V _{IT+}	Receiver positive-going differential input threshold voltages	I _{OH} = -8 mA,		See Figure 4			0.2	V
V _{IT}	Receiver negativegoing differential input threshold voltage	I _{OL} = 8 mA,		SeeFigure 4	-0.2			V
V_{hys}	Receiver input hysteresis (V _{IT+} – V _{IT-})	V _{CC} = 5 V,	T _A = 25°C		24	45		mV
	Bus input current	V _{IH} = 12 V	V _{CC} = 5 V,				1	mA
		V _{IH} = 12 V	$V_{CC} = 0$,	Other insert at 0.1/			1	mA
I _I		V _{IH} = −7 V	V _{CC} = 5 V,	Other input at 0 V	-0.8	-0.4		mA
		V _{IH} = −7 V	$V_{CC} = 0$,		-0.8	-0.3		mA
	Libert Level in a stronger	nA, BSR, DE/RE,	and CRE,	V _{IH} = 2 V	-100			μΑ
I _{IH}	High-level input current	CDE0, CDE1, and	CDE2,	V _{IH} = 2V			100	μΑ
		nA, BSR, DE/RE,	and CRE,	V _{IL} = 0.8 V	-100			μΑ
I _{IL}	Low-level input current	CDE1, CDE1, and	CDE2,	V _{IL} = 0.8 V			100	μΑ
los	Short circuit output current	nB+ or nB-					±260	mA
	High-impedance-state output	nA			Se	e I _{IH} and I _{IL}		
loz	current	nB+ or nB-				See I _{II}		
		Disabled					10	
I _{CC}	Supply current	All drivers enabled	l, no load				60	mA
		All receivers enabled, no load					45	
Co	Output capacitance	nB+ or nB- to GNI	D			18	25	pF
<u></u>	Dower dissipation conscitance (2)	Receiver				40		n.E
C_{pd}	Power dissipation capacitance (2)	Driver			100			pF

⁽¹⁾ All typical values are at V_{CC} = 5 V, T_A = 25°C. (2) C_{pd} determines the no-load dynamic supply current consumption, I_S = C_{PD} × V_{CC} × f + I_{CC}



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008 www.ti.com

DRIVER SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	SN	LIMIT		
	PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
t _{pd}	Propagation delay time, t _{PHL} or t _{PLH} (see Figure 2 and Figure 3)		2.5		13.5	ns
t _{sk(p)}	Pulse skew, t _{PHL} - t _{PLH}				4	ns
t _f	Fall time	S1 to B, See Figure 3		4		ns
t _r	Rise time	See Figure 3		8		ns
t _{en}	Enable time, control inputs to active output				50	ns
t _{dis}	Disable time, control inputs to high-impedance output				100	ns
t_{PHZ}	Propagation delay time, high-level to high-impedance output			17	100	ns
t _{PLZ}	Propagation delay time, low-level to high-impedance output	See Figure 6 and		25	100	ns
t _{PZH}	Propagation delay time, high-impedance to high-level output	Figure 7		17	50	ns
t _{PZL}	Propagation delay time, high-impedance to low-level output			17	50	ns

⁽¹⁾ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

RECEIVER SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

DADAMETED		TEST COMPITIONS	SI	LINUT		
	PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT
t _{pd}	Propagation delay time, t _{PHL} or t _{PLH} (see Figure 2 and Figure 3)		8.5		14.5	ns
t _{sk(lim)}	Skew limit, maximum t _{pd} – minimum t _{pd} ⁽²⁾				5	ns
t _{sk(p)}	Pulse skew, t _{PHL} - t _{PLH}			0.6	4	ns
t _t	Transition time (t _r or t _f)	See Figure 5		2		ns
t _{en}	Enable time, control inputs to active output				50	ns
t _{dis}	Disable time, control inputs to high-impedance output				60	ns
t _{PHZ}	Propagation delay time, high-level to high-impedance output				60	ns
t _{PLZ}	Propagation delay time, low-level to high-impedance output	See Figure 8 and			50	ns
t _{PZH}	Propagation delay time, high-impedance to high-level output	Figure 9			50	ns
t _{PZL}	Propagation delay time, high-impedance to low-level output				50	ns

Submit Documentation Feedback

All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. This parameter is applicable at one V_{CC} and operating temperature within the recommended operating conditions and to any two

www.ti.com

Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008

PARAMETER MEASUREMENT INFORMATION

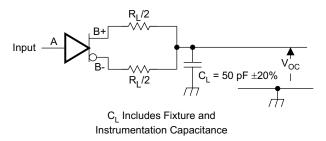
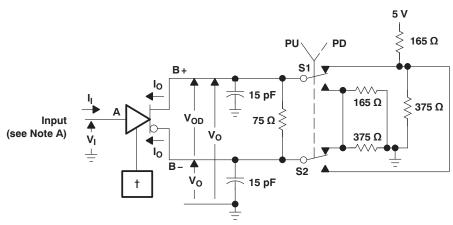


Figure 1. Driver Test Circuit, RS-422 and RS-485 Loading



- † CDEO and DE/ $\overline{\rm RE}$ are at 2 V, BSR is at 0.8V, and all others are open.
- [‡] All nine drivers are enabled, similarly loaded, and switching.

Figure 2. Driver Test Circuit, Pull-Up and Pull-Down Loading[‡]

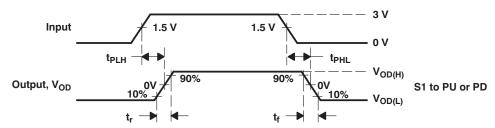


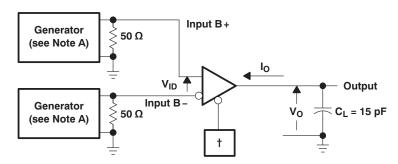
Figure 3. Driver Delay and Transition Time Test Waveforms

SN65HVD09



SLLS941-DECEMBER 2008 www.ti.com

PARAMETER MEASUREMENT INFORMATION (continued)



- † CDEO, CDE1, CDE2, BSR, CRE, and DE/RE at 0.8 V
- [‡] All nine receivers are enabled and switching.

Figure 4. Receiver Propagation Delay and Transition Time Test Circuit

- A. All input pulses are supplied by a generator having the following characteristics: $t_r \le 6$ ns, $t_f \le 6$ ns, PRR ≤ 1 MHz, duty cycle = 50%, $Z_O = 50$ Ω .
- B. All resistances are in Ω and $\pm 5\%$, unless otherwise indicated.
- C. All capacitances are in pF and ±10%, unless otherwise indicated.
- D. All indicated voltages are ±10 mV.

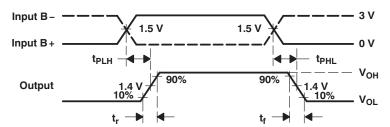
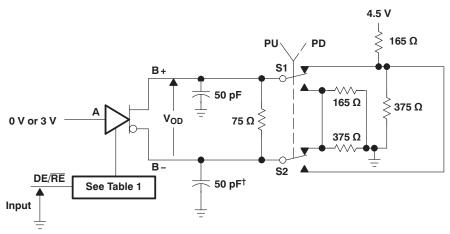


Figure 5. Receiver Delay and Transition Time Waveforms



[†] Includes probe and jig capacitance in two places.

Figure 6. Driver Enable and Disable Time Test Circuit

SN65HVD09

www.ti.com SLLS941-DECEMBER 2008

Table 1. Enabling for Driver Enable and Disable Time

DRIVER	BSR	CDE0	CDE1	CDE2	CRE
1–8	Н	Н	L	L	X
9	L	Н	Н	Н	Н

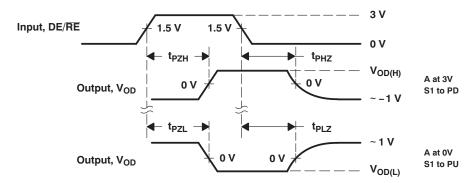
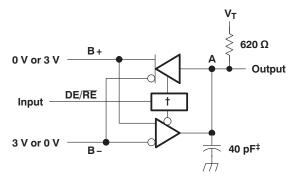


Figure 7. Driver Enable Time Waveforms

NOTES: A. All input pulses are supplied by a generator having the following characteristics: $t_r \le 6$ ns, $t_f \le 6$ ns, PRR ≤ 1 MHz, duty cycle = 50%, $Z_O = 50$ Ω .

- B. All resistances are in Ω and $\pm 5\%$, unless otherwise indicated.
- C. All capacitances are in pF and ±10%, unless otherwise indicated.
- D. All indicated voltages are ±10 mV.



 $^{^\}dagger$ CDEO is high, CDE1, CDE2, BSR, and $\overline{\mbox{CRE}}$ are low, all others are open.

Figure 8. Receiver Enable and Disable Time Test Circuit

[‡] Includes probe and jig capacitance.

Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

TEXAS INSTRUMENTS

SN65HVD09

SLLS941-DECEMBER 2008

www.ti.com

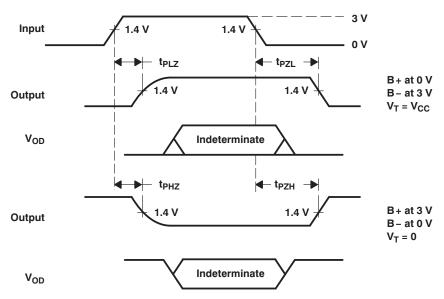


Figure 9. Receiver Enable and Disable Time Waveforms

- NOTES: A. All input pulses are supplied by a generator having the following characteristics: $t_r \le 6$ ns, $t_f \le 6$ ns, PRR ≤ 1 MHz, duty cycle = 50%, $Z_O = 50$ Ω .
 - B. All resistances are in Ω and ±5%, unless otherwise indicated.
 - C. All capacitances are in pF and ±10%, unless otherwise indicated.
 - D. All indicated voltages are ±10 mV.

www.ti.com

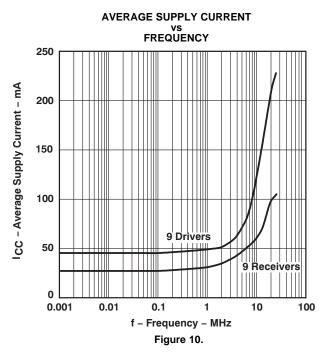
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

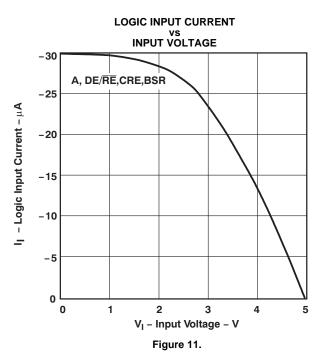


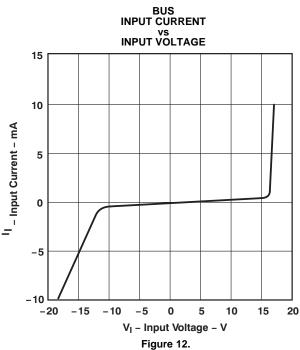
SN65HVD09

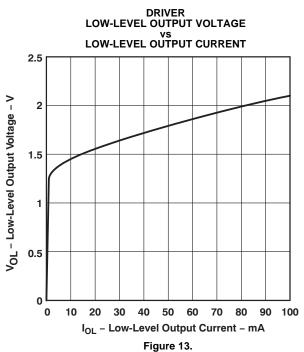
SLLS941-DECEMBER 2008

TYPICAL CHARACTERISTICS









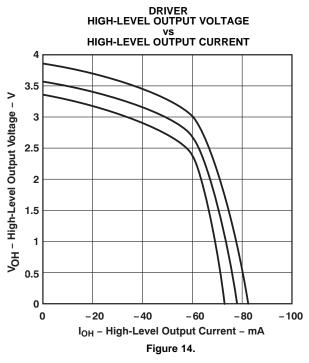
Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

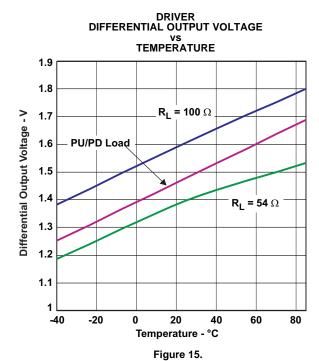




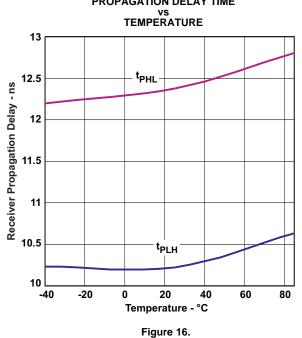
SLLS941-DECEMBER 2008 www.ti.com

TYPICAL CHARACTERISTICS (continued)





RECEIVER PROPAGATION DELAY TIME



DRIVER PROPAGATION DELAY TIME

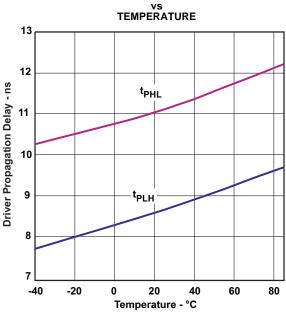


Figure 17.

www.ti.com

Distributor of Texas Instruments: Excellent Integrated System Limited

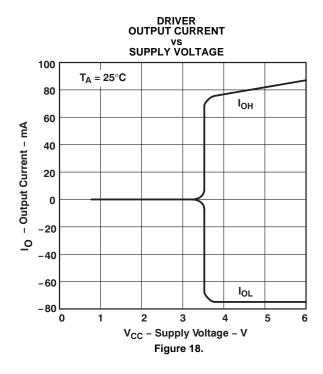
Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008

TYPICAL CHARACTERISTICS (continued)



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

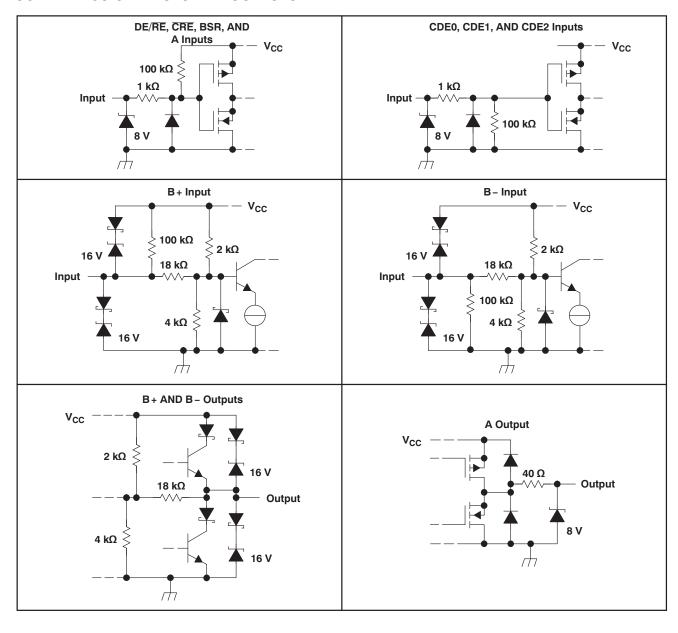




SLLS941-DECEMBER 2008 www.ti.com

TYPICAL CHARACTERISTICS (continued)

SCHEMATICS OF INPUTS AND OUTPUTS



www.ti.com

Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



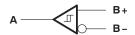
SN65HVD09

SLLS941-DECEMBER 2008

APPLICATION INFORMATION

FUNCTION TABLES

RECEIVER



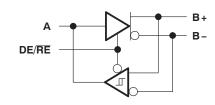
I	INP	OUTPUT	
	B+1	B+1 B-1	
I	L	Н	L
ı	Н	L	Н

DRIVER



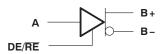
INPUT	OUTPUTS		
Α	B+	B-	
L	L	Н	
Н	Н	L	

TRANSCEIVER



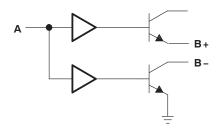
	INPU	OUTPUTS				
DE/RE	Α	B+1	B-1	Α	B+	B-
L	L - L L - H		Н	L	-	-
L			H L	Н	-	-
Н	L	_	-	_	L	Н
I н	Н	_	_	l _	Н	- 1

DRIVER WITH ENABLE



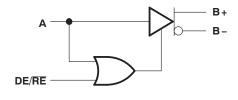
INPUT	S	OUTPUTS			
DE/RE A		B+	B-		
L	L	Z	Z		
L	Н	Z	Z		
Н	L	L	Н		
Н	Н	Н	L		

WIRED-OR DRIVER



INPUT	OUTPUTS				
Α	B+	B-			
L	Z	Z			
Н	Н	L			

TWO-ENABLE INPUT DRIVER



INPUT	rs	OUTPUTS			
DE/RE	Α	B+	B-		
L	L	Z	Z		
L	Н	Н	L		
Н	L	L	Н		
Н	Н	Н	L		

NOTE: H = high level, L = low level, X = irrelevant, Z = high impedance (off)

(1) An H in this column represents a voltage of 200 mV or higher than the other bus input. An L represents a voltage of 200 mV or lower than the other bus input. Any voltage less than 200 mV results in an indeterminate receiver output.

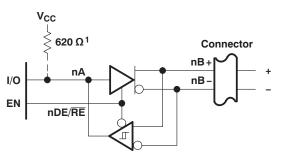
Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

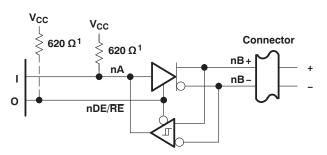


SN65HVD09

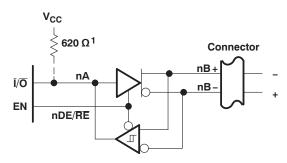
SLLS941-DECEMBER 2008 www.ti.com



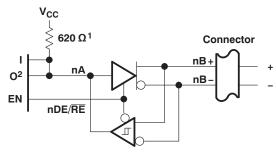
(a) ACTIVE-HIGH BIDIRECTIONAL I/O WITH SEPARATE ENABLE



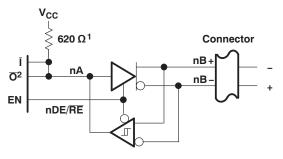
(c) WIRED-OR DRIVER AND ACTIVE-HIGH INPUT



(b) ACTIVE-LOW BIDIRECTIONAL I/O WITH SEPARATE ENABLE



(d) SEPARATE ACTIVE-HIGH INPUT, OUTPUT, AND ENABLE





- - (f) WIRED-OR DRIVER AND ACTIVE-LOW INPUT

- 1: When 0 is open drain
- 2: Must be open-drain or 3-state output
 - (1) When 0 is open drain
 - (2) Must be open-drain or 3-state output

NOTE: The BSR, $\overline{\text{CRE}}$, A, and DE/ $\overline{\text{RE}}$ inputs have internal pullup resistors. CDE0, CDE1, and CDE2 have internal pulldown resistors.

Figure 19. Typical Transceiver Connections

Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

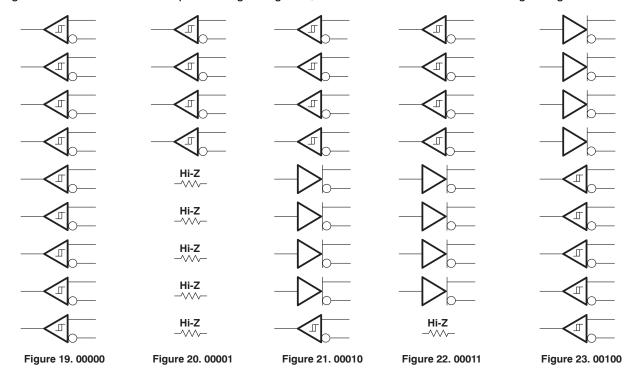


SN65HVD09

www.ti.com SLLS941-DECEMBER 2008

CHANNEL LOGIC CONFIGURATIONS WITH CONTROL INPUT LOGIC

The following logic diagrams show the positive-logic representation for all combinations of control inputs. The control inputs are from MSB to LSB; the BSR, CDE0, CDE1, CDE2, and $\overline{\text{CRE}}$ bit values are shown below the diagrams. Channel 1 is at the top of the logic diagrams; channel 9 is at the bottom of the logic diagrams.



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008 www.ti.com

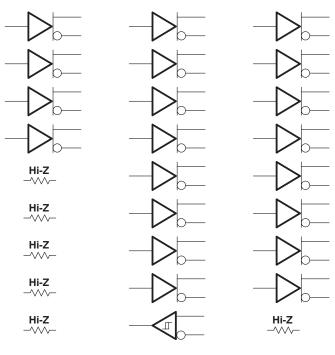


Figure 24. 00101 Figure 25. 00110 Figure 26. 00111

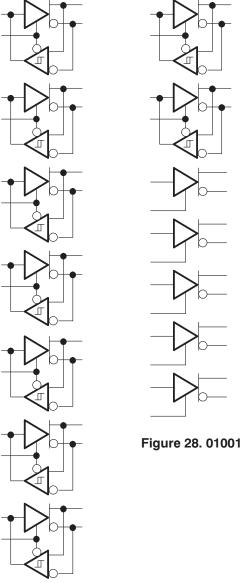


Figure 27. 01000

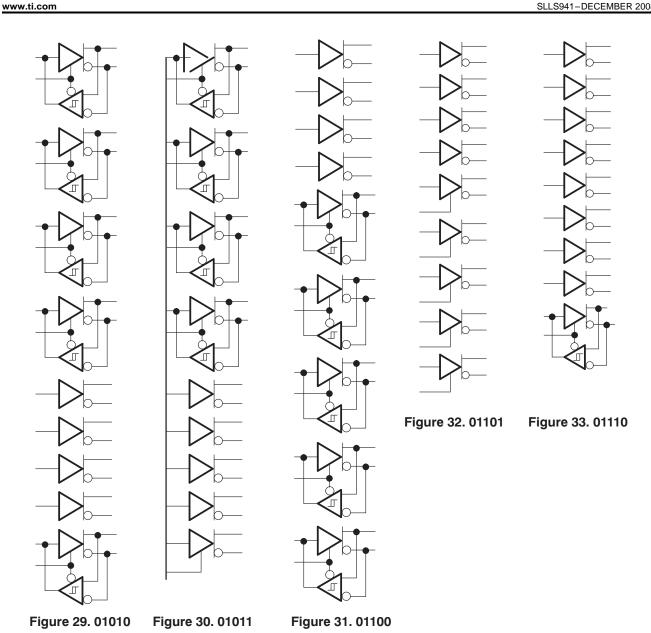


Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN65HVD09

SLLS941-DECEMBER 2008



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

TEXAS INSTRUMENTS

SLLS941-DECEMBER 2008

Figure 34. 01111

SN65HVD09

www.ti.com

 v_{cc}

 v_{cc}

 v_{cc}

 v_{cc}

 $\mathbf{v}_{\mathbf{cc}}$

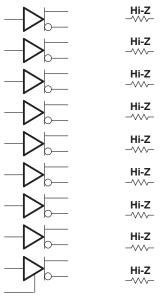
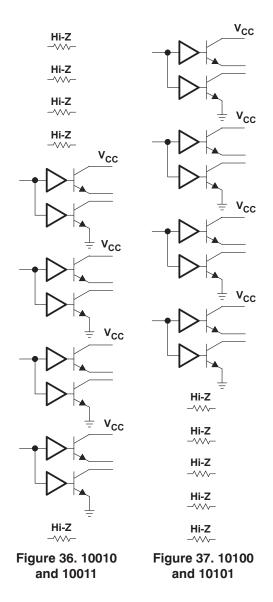


Figure 35. 10000 and 10001



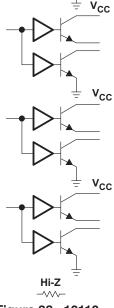


Figure 38. 10110 and 10111

SN65HVD09

SLLS941-DECEMBER 2008

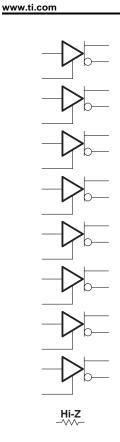


Figure 39. 11000 and 11001

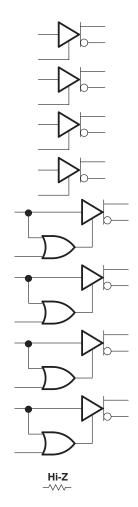
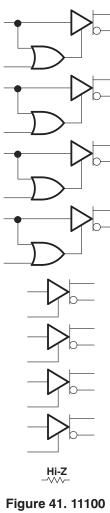


Figure 40. 11010 and 11011



and 11101

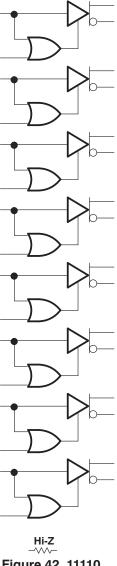


Figure 42. 11110 and 11111

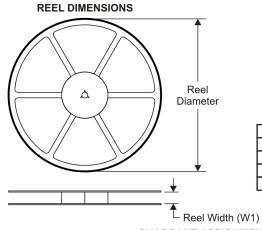
Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

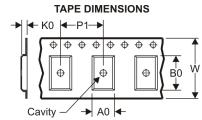


PACKAGE MATERIALS INFORMATION

20-Dec-2008

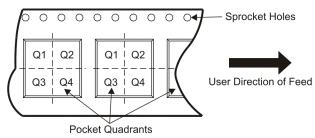
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN65HVD09DGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1

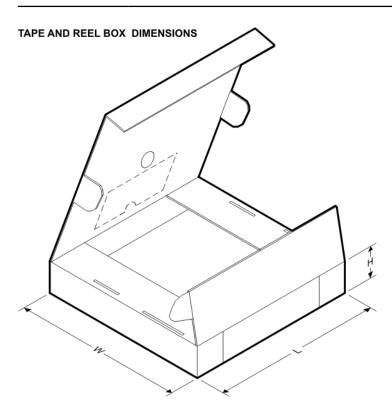


Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



PACKAGE MATERIALS INFORMATION

20-Dec-2008



*All dimensions are nominal

7 til dillionorio are memilia								
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN65HVD09DGGR	TSSOP	DGG	56	2000	346.0	346.0	41.0	



Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

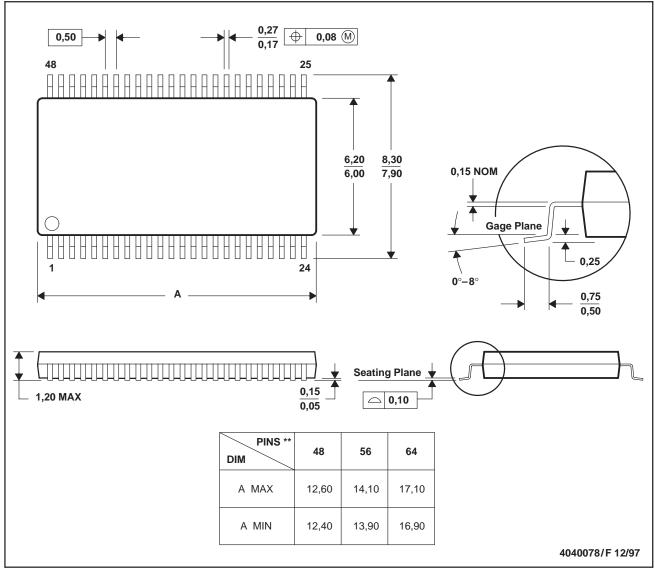
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153





Datasheet of SN65HVD09DGGR - IC TXRX 9CH RS485-RS422 56-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products Amplifiers amplifier.ti.com Data Converters dataconverter.ti.com DSP dsp.ti.com Clocks and Timers www.ti.com/clocks Interface interface.ti.com Logic logic.ti.com Power Mgmt power.ti.com Microcontrollers microcontroller.ti.com www.ti-rfid.com RF/IF and ZigBee® Solutions www.ti.com/lprf

Applications Audio www.ti.com/audio Automotive www.ti.com/automotive Broadband www.ti.com/broadband **Digital Control** www.ti.com/digitalcontrol Medical www.ti.com/medical Military www.ti.com/military Optical Networking www.ti.com/opticalnetwork Security www.ti.com/security Telephony www.ti.com/telephony Video & Imaging www.ti.com/video www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated